MG7211WZ

1200V 15A Insulated Gate Bipolar Transistor

Datasheet

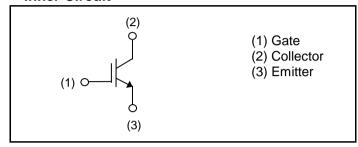
V _{CES}	1200V
I _{C (Nominal)}	15A
V _{CE(sat) (Typ.)}	1.7V
Max. Possible Chips per Wafer	641pcs

● Outline Wafer

Features

- 1) Trench Light Punch Through Type
- 2) Low Collector Emitter Saturation Voltage
- 3) Short Circuit Withstand Time 10µs

●Inner Circuit



Application

General Inverter

for Automotive and Industrial Use

Heater for Automotive

Absolute Maximum Ratings

- 7 1.500 1.610 1.16211.16111.190			
Parameter	Symbol	Value	Unit
Collector - Emitter Voltage, T _j = 25°C	V _{CES}	1200	V
Gate - Emitter Voltage	V _{GES}	±30	V
Collector Current	I _C ^{*1}	*1)	А
Pulsed Collector Current	I _{CP} ^{*2}	45	А
Operating Junction Temperature	Tj	-40 to +175	°C

^{*1} Depending on thermal properties of assembly

^{*2} Pulse width limited by T_{imax.}

●Design Assurance

Parameter	Symbol	Conditions	Values			Unit
raiailletei			Min.	Тур.	Max.	Offic
		$V_{CC} \le 600V$, $V_{GE} = 15V$, $T_j = 25^{\circ}C$				
Short Circuit Withstand Time	t _{sc} *3	$V_{GE} = 15V$,	10	-	-	μs
		T _j = 25°C				
Short Circuit Withstand Time		$V_{CC} \le 600V$,				
	t _{sc} *3	$V_{GE} = 15V$, $T_j = 150^{\circ}C$	8	-	-	μs
		$T_j = 150^{\circ}C$				
		$I_C = 45A, V_{CC} = 1050V,$	FULL SQUARE			
Reverse Bias Safe Operating Area	RBSOA*3	$I_C = 45A$, $V_{CC} = 1050V$, $V_P = 1200V$, $V_{GE} = 15V$, $R_G = 50\Omega$, $T_j = 175^{\circ}C$			-	
		$R_G = 50\Omega, T_j = 175^{\circ}C$				

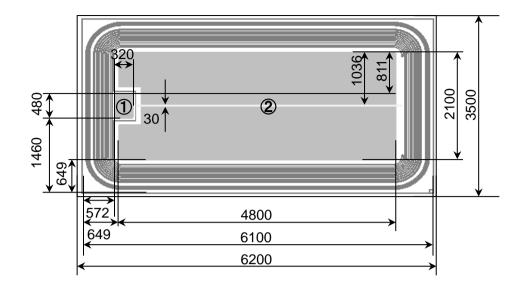
^{*3} Design assurance without measurement

● Electrical Characteristics (at T_i = 25°C unless otherwise specified, in case of TO-247N package)

Doromotor	Cymphal	Conditions	Values			l limit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Collector - Emitter Breakdown Voltage	BV _{CES}	$I_{C} = 10 \mu A, V_{GE} = 0 V$	1200	1	-	V
Collector Cut - off Current	I _{CES}	V _{CE} = 1200V, V _{GE} = 0V	-	1	10	μΑ
Gate - Emitter Leakage Current	I _{GES}	$V_{GE} = \pm 30V, V_{CE} = 0V$	-	ı	±500	nA
Gate - Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 5V, I_{C} = 2.3mA$	5.0	6.0	7.0	V
Collector - Emitter Saturation Voltage		$I_C = 15A$, $V_{GE} = 15V$, $T_j = 25$ °C $T_j = 175$ °C	-	1.7 2.2	2.1	٧
Input Capacitance	C _{ies}	V _{CE} = 30V,	-	1272	-	
Output Capacitance	C _{oes}	$V_{GE} = 0V$,	-	66	-	pF
Reverse transfer Capacitance	C _{res}	f = 1MHz	-	8	-	
Total Gate Charge	Q_g	V _{CE} = 500V,	-	41	-	
Gate - Emitter Charge	Q_ge	I _C = 15A,	-	11	-	nC
Gate - Collector Charge	Q_{gc}	V _{GE} = 15V	-	17	-	

^{*3} Design assurance without measurement

●Chip Information



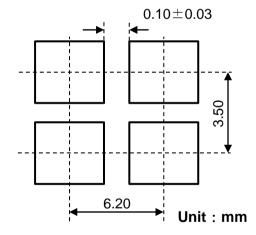
Unit: µm

: Pad Area

1 : Gate Bonding Pad

2 : Emitter Bonding Pad

Backside : Collector



Wafer Size	150mm
Wafer Thickness	0.14±0.01mm
Chip Size	6.20mm×3.50mm
Cut Line Width	0.10±0.03mm
Top Side Metallization	AlSiCu:4.4µm
Back Side Metallization	Ti/Ni:0.4µm/Au:0.05µm
Passivation	Polyimide

•Further Electrical Characteristics

Switching characteristics and thermal properties are depending strongly on module design and mounting technology and can therefore not be specified for a bare die.

This chip data sheet refers to the device data sheet	RGS30TSX2

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